

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

SAW Components

SAW Duplexer

Automotive telematics

Series/type:B4400Ordering code:B39212B4400P810

Date:November 07, 2014Version:2.3

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SAW Duplexer Automotive telematics

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1950.0 / 2140.0 MHz

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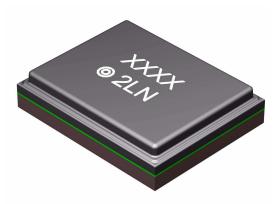
SAW Duplexer

Data sheet

SMD

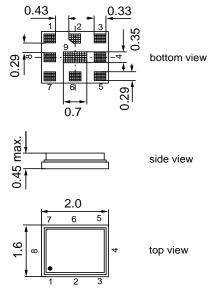
Application

- Low-loss SAW duplexer for W-CDMA Band 1 (UMTS) systems
- Low insertion attenuation
- Low amplitude ripple
- Usable passband 60 MHz
- Single-ended to balanced transformation in Antenna-Rx path
- Impedance transformation 50 Ω to 100 Ω in Antenna-Rx path
- High isolation between Tx and Rx



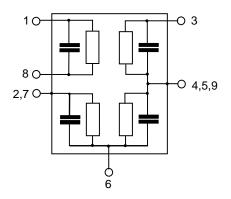
Features

- Package size 2.0 * 1.6 mm²
- Package height max. 0.45mm
- RoHS compatible
- Approximate weight 0.005 g
- Package for Surface Mount Technology (SMT)
- Ni terminals, Au-plated
- AEC-Q200 qualified component family (operable temperature range -40°C to +85°C)
- Electrostatic Sensitive Device (ESD)



Pin configuration

- 3 Tx input
- 1,8 Rx output (balanced)
- 6 Antenna
- 2, 4, 5, 7, 9 To be grounded



2

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Data sheet

Characteristics

Γ =	–20 °C to +85 °
$Z_{Tx} =$	50 Ω 6.0 nH
$Z_{Ant} =$	50 Ω 2.2 nH
$Z_{Rx} =$	100 Ω (balance
	Z _{Tx} = Z _{Ant} =

Characteristics Tx-Antenna		min.	typ. @ 25 °C	max.	
Center frequency	f _c		1950.0		MHz
Maximum insertion attenuation	$\alpha_{W-CDMA}^{(1)}$				
1922.4 1977.6	MHz	—	1.7	2.3	dB
Amplitude ripple (p-p)	$\alpha_{W-CDMA}^{(1)}$				
1922.4 1977.6	MHz	_	0.5	1.1	dB
Error Vector Magnitude	EVM ²⁾				
1922.4 1977.6	MHz	_	1.4	2.3	%
TX port VSWR					
1920.0 1980.0	MHz	_	1.6	2.0	
ANT port VSWR					
1920.0 1980.0	MHz	—	1.4	2.0	
Attenuation	α				
10.0 410.0	MHz	45	69		dB
420.0 494.0	MHz	43	64	_	dB
843.0 894.0	MHz	40	47		dB
1565.0 1574.0	MHz	41	45		dB
1574.0 1577.0	MHz	42	46		dB
1577.0 1586.0	MHz	42	47	—	dB
1597.0 1605.0	MHz	43	48	—	dB
1605.0 1805.0	MHz	34	39	—	dB
1805.0 1865.0	MHz	30	36	—	dB
1865.0 1880.0	MHz	12	33	—	dB
2112.4 2167.6	MHz $\alpha_{W-CDMA}^{(1)}$	46	54	—	dB
2400.0 2500.0	MHz	31	38	—	dB
2620.0 2690.0	MHz	30	36	—	dB
3830.0 3970.0	MHz	28	34	—	dB
5150.0 5950.0	MHz	18	22		dB

¹⁾ Attenuation of W-CDMA signal (Power Transfer Function). Please, refer to page 7 of this document.

3

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141

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°C Н

ed) || 17 nH

B4400



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Data sheet

Characteristics

Temperature range for specification:	$T = -20 \degree C \text{ to } +85 \degree C$
TX terminating impedance:	Z _{Tx} = 50 Ω 6.0 nH
ANT terminating impedance:	$Z_{Ant} = 50 \Omega 2.2 \text{ nH}$
RX teminating impedance:	$Z_{Rx} = 100 \Omega$ (balanced) 17 nH

Characteristics Antenna-Rx			min.	typ. @ 25 °C	max.	
Center frequency		f _c		2140.0		MHz
Maximum insertion attenuation		$\alpha_{W-CDMA}^{(1)}$				
2112.4 2167.6	MHz			2.2	2.4	dB
Amplitude ripple (p-p) 2112.4 2167.6	MHz	$\alpha_{W\text{-}CDMA}^{(1)}$		0.4	0.0	dB
			_	0.4	0.8	uD
Error Vector Magnitude 2112.4 2167.6	MHz	EVM ²⁾	—	1.0	2.0	%
ANT port VSWR						
2110.0 2170.0	MHz		_	1.8	2.2	
RX port VSWR						
2110.0 2170.0	MHz		_	1.6	2.0	

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¹⁾ Attenuation of W-CDMA signal (Power Transfer Function). Please, refer to page 7 of this document.

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141

4





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Data sheet

Characteristics

Temperature range for specification:
TX terminating impedance:
ANT terminating impedance:

ANI terminating impedance: RX teminating impedance: $\begin{array}{lll} Z_{\mathsf{Tx}} &=& 50 \; \Omega \; || \; 6.0 \; \mathsf{nH} \\ Z_{\mathsf{Ant}} &=& 50 \; \Omega \; || \; 2.2 \; \mathsf{nH} \\ Z_{\mathsf{Rx}} &=& 100 \; \Omega \; (\mathsf{balanced}) \; || \; 17 \; \mathsf{nH} \end{array}$

T = -20 °C to +85 °C

Characteristics Antenna-Rx		min.	typ. @ 25 ℃	max.		
Attenuation		α				
10.0	1920.0	MHz	45	53		dB
1922.4	1977.6	MHz $\alpha_{W-CDMA}^{(1)}$	50	55		dB
1980.0	2025.0	MHz	33	49		dB
2255.0	2400.0	MHz	25	45		dB
2400.0	2484.0	MHz	41	44		dB
2484.0	5600.0	MHz	40	45		dB
5600.0	6000.0	MHz	28	32		dB

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¹⁾ Attenuation of W-CDMA signal (Power Transfer Function). Please, refer to page 7 of this document.

5

B4400



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Data sheet

Characteristics

Temperature range for specification:	$T = -20 \degree C \text{ to } +85 \degree C$
TX terminating impedance:	Z _{Tx} = 50 Ω 6.0 nH
ANT terminating impedance:	$Z_{Ant} = 50 \Omega 2.2 \text{ nH}$
RX teminating impedance:	$Z_{Rx} = 100 \Omega$ (balanced) 17 nH

Characteristics Tx-Rx		min.	typ. @ 25 °C	max.	
Differential Mode Isolation	α				
1574.0 1577.0 MHz	2	40	79	—	dB
1922.4 1977.6 MHz	$\alpha_{W-CDMA}^{(1)}$	52	57	—	dB
2112.4 2167.6 MHz		53	59	—	dB
3830.0 3970.0 MHz	2	30	61	—	dB
5750.0 5950.0 MHz	2	30	44	—	dB
Common Mode Isolation	α				
1922.4 1977.6 MHz	$\alpha_{W-CDMA}^{(1)}$	42	45	—	dB

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¹⁾ Attenuation of W-CDMA signal (Power Transfer Function). Please, refer to page 7 of this document.

6

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Annotation for characteristics section

Attenuation of W-CDMA signal (Power Transfer Function, α_{W-CDMA}) is determined by

$$\int_{-\infty}^{\infty} \left| S_{ds21}(f) H_{RRC}(f - f_{Carrier}) \right|^2 df$$

with $\rm f_{Carrier}$ according to 3GPP TS 25.101 (e.g. for UMTS pass band, $\rm f_{Carrier}$ ranges from 1922.4 MHz (lowest Tx channel) to 2167.6 MHz (highest Tx channel)). Here, $\rm H_{RRC}(f)$ is the transfer function of the root-raised cosine transmit pulse shaping filter according to 3GPP TS 25.101 with the following normalization:

$$\int_{-\infty}^{\infty} \left| H_{RRC}(f) \right|^2 df = 1$$



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Maximum Ratings

Operable temperature range	Т	-40/+85	°C	
Storage temperature range	T _{stg}	-40/+85	°C	
DC voltage	V _{DC}	0	V	
ESD voltage	V_{ESD}	50 ¹⁾	V	machine model, 10 pulses
Input power at				
1920.0 1980.0 MHz	P _{in}	29	dBm	<pre>} continuous wave</pre>
elsewhere	P _{in}	10	dBm	J 50 °C, 5000h

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¹⁾ According to JESD22-A115A (machine model), 10 negative and 10 positive pulses.

8

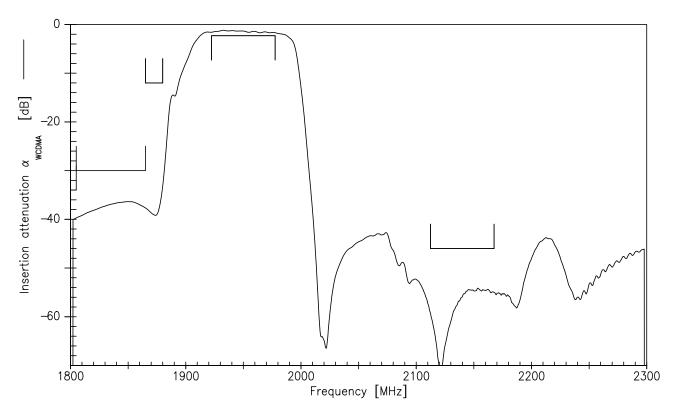


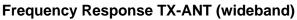
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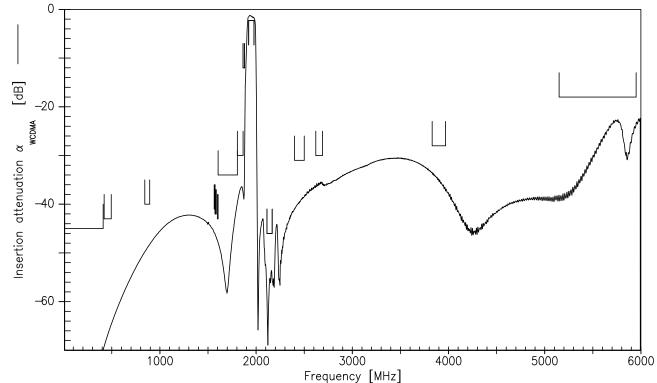
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Frequency Response TX-ANT







9

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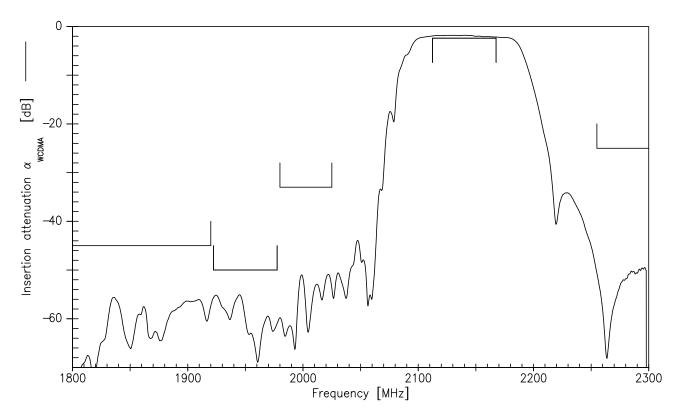
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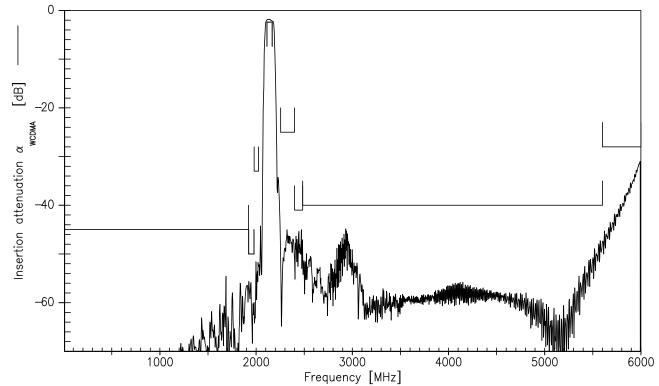
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Frequency Response RX-ANT



Frequency Response RX-ANT (wideband)



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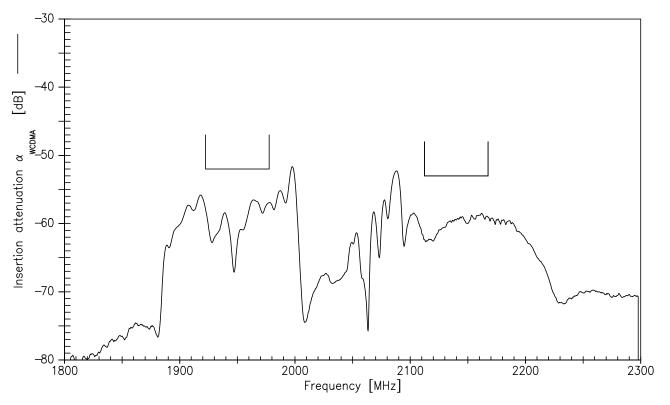


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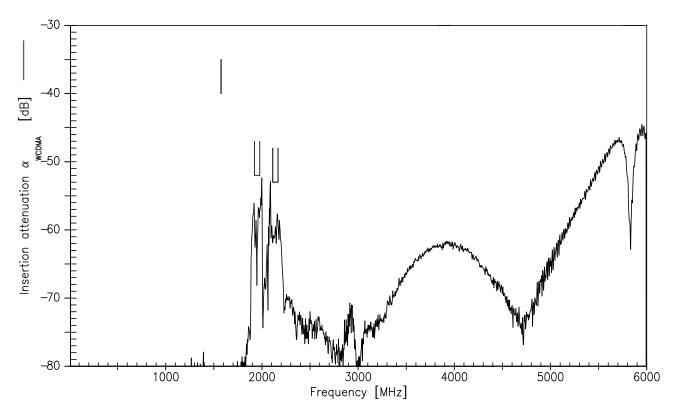
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Frequency Response TX-RX

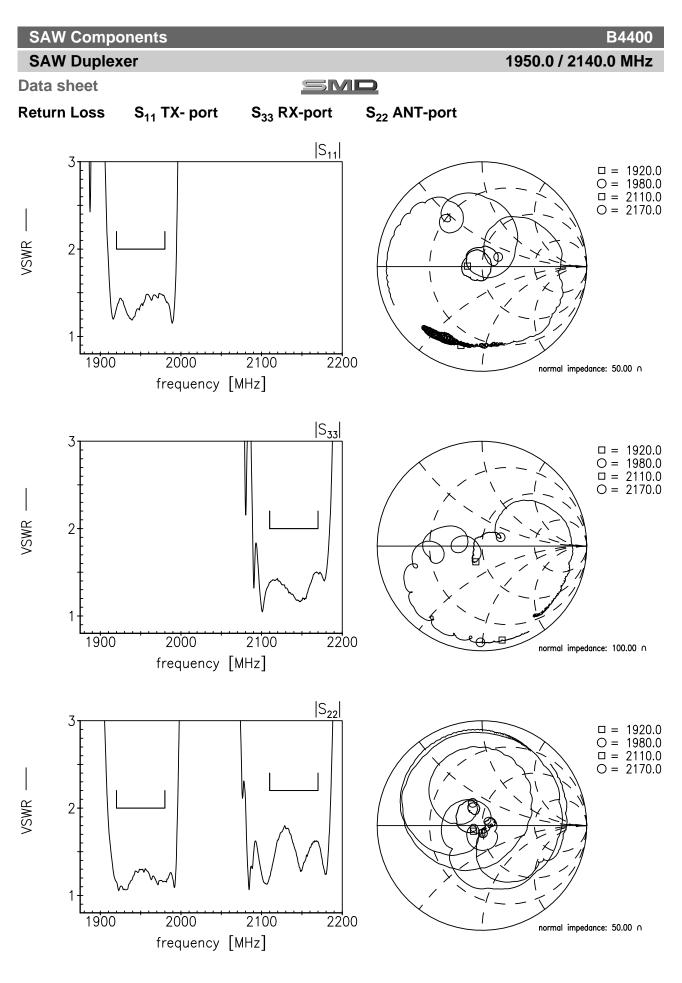


Frequency Response TX-RX (wideband)



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12

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References

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Туре	B4400
Ordering code	B39212B4400P810
Marking and package	C61157-A8-A50
Packaging	F61074-V8247-Z000
Date codes	L_1126
S-parameters	B4400_NB_UN.s4p, B4400_WB_UN.s4p See file header for port/pin assignment table.
Soldering profile	S_6001
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Di- rective 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.
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